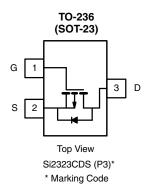




# P-Channel 20 V (D-S) MOSFET

MOSFET PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
	0.039 at V <sub>GS</sub> = -4.5 V	-6 <sup>e</sup>			
-20	0.050 at V <sub>GS</sub> = -2.5 V	-5.8	9 nC		
	0.063 at V <sub>GS</sub> = -1.8 V	-5.1			



#### Ordering Information:

Si2323CDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



HALOGEN **FREE** 

## **APPLICATIONS**

- Load Switch
- PA Switch
- DC/DC Converters

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	-20	V		
Gate-Source Voltage	V <sub>GS</sub>	± 8	]		
	T <sub>C</sub> = 25 °C		-6 <sup>e</sup>		
Continuous Drain Current (T, = 150 °C)	T <sub>C</sub> = 70 °C	, [	-5.2	A	
Continuous Diain Guitent (1 j = 130 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	-4.6 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		-3.7 <sup>b, c</sup>		
Pulsed Drain Current	I <sub>DM</sub>	-20			
Continuous Course Prais Diade Current	T <sub>C</sub> = 25 °C	I-	-2.1	ı	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	ls -	-1 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		2.5		
Maximum Dawar Dissination	T <sub>C</sub> = 70 °C	P <sub>D</sub>	1.6	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	LD L	1.25 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		0.8 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stq</sub>	-55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient <sup>b, d</sup>	≤ 5 s	R <sub>thJA</sub>	75	100	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	40	50	- C/VV		

#### Notes:

- a. Based on  $T_C$  = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 166 °C/W.
- e. Package limited.

Document Number: 65700 S13-2081-Rev. B, 30-Sep-13

# Si2323CDS

# Vishay Siliconix



<b>MOSFET SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{DS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	-20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = -250 μA		-14		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	В .		2.4		11107 0	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.4		-1	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA	
Zero Gate Voltage Drain Current	l	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$			-1		
Zero date voltage Diam Current	I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			-10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-20			Α	
		V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -4.6 A		0.032	0.039		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -4.1 A		0.041	0.050	Ω	
		V <sub>GS</sub> = -1.8 V, I <sub>D</sub> = -3.6 A		0.050	0.063		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -5 \text{ V}, I_{D} = -4.6 \text{ A}$		20		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			1090		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		155			
Reverse Transfer Capacitance	C <sub>rss</sub>			135			
Total Gate Charge	$Q_g$	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -4.6 \text{ A}$	4.6 A 16	25			
Total Gate Charge	<b>∢</b> g			9.3	15	1	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -10 \text{ V}, V_{GS} = -2.5 \text{ V}, I_D = -4.6 \text{ A}$		2.5		nC	
Gate-Drain Charge	$Q_{gd}$			3.2			
Gate Resistance	$R_g$	f = 1 MHz	0.8	4.1	8.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			15	23		
Rise Time	t <sub>r</sub>	$V_{DD}$ = -10 V, $R_L$ = 2.7 $\Omega$		23	35	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D = -3.7 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		40	60		
Fall Time	t <sub>f</sub>			12	20		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			-2.1	Α	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				-20		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = -3.7 A		-0.8	-1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			30	45	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = -3.7 \text{ A, dl/dt} = 100 \text{ A/µs, } I_J = 25 \text{ °C}$		20	40	nC	
Reverse Recovery Fall Time	t <sub>a</sub>			17		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			13			

#### Notes:

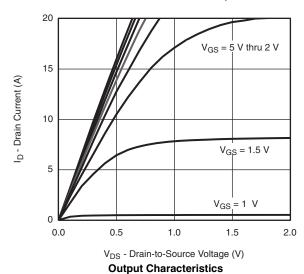
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

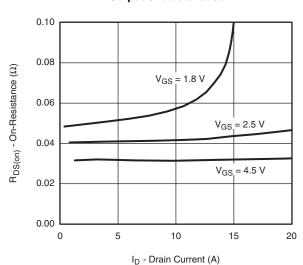
a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

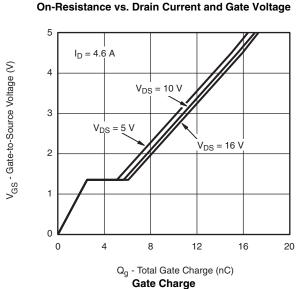
b. Guaranteed by design, not subject to production testing.

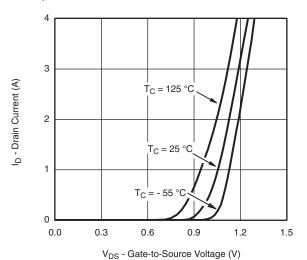


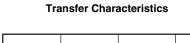
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

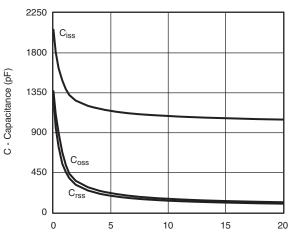




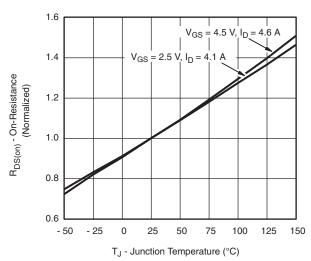








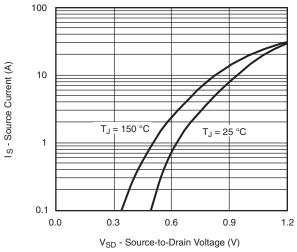
 $V_{DS}$  - Drain-to-Source Voltage (V) **Capacitance** 



On-Resistance vs. Junction Temperature

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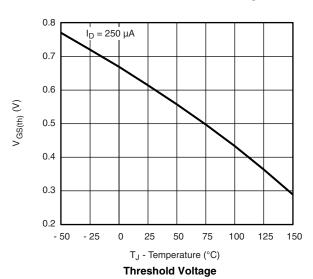
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

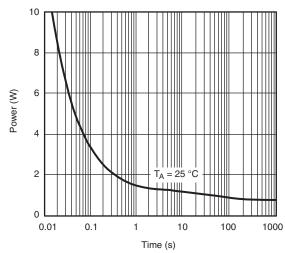


 $I_D = 4.6 \text{ A}$ 0.12 R<sub>DS(on)</sub> - On-Resistance (Ω) 0.09 0.06 T<sub>J</sub> = 125 °C 0.03 T<sub>J</sub> = 25 °C 0.00

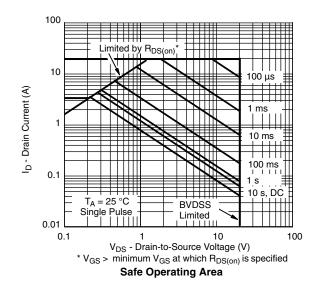
Source-Drain Diode Forward Voltage

V<sub>GS</sub>- Gate-to-Source Voltage (V) On-Resistance vs. Gate-to-Source Voltage



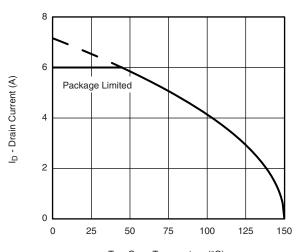


Single Pulse Power



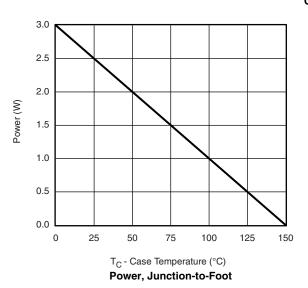


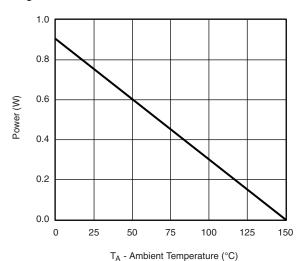
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



T<sub>C</sub> - Case Temperature (°C)

Current Derating\*



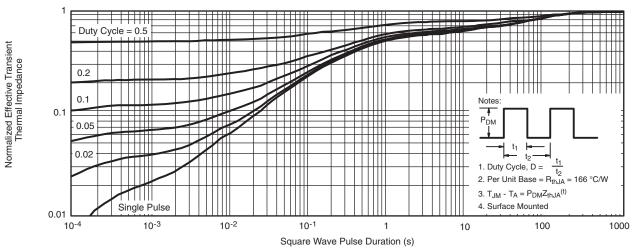


Power, Junction-to-Ambient

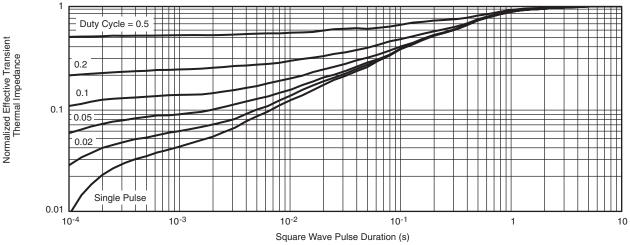
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max.)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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## SOT-23 (TO-236): 3-LEAD







Dim	MILLIMETERS		INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.9	5 BSC	0.037	4 Ref	
e <sub>1</sub>	1.9	0 BSC	0.074	8 Ref	
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
FCN: S-03946-Rev K 09-	lul-01	•			

ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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